





160909 1/10/94

Docket: 0756-935

Date: December 3, 1993

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Honorable Commissioner of Patents and Trademarks Washington, D.C. 20231

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Sir:						
	Transmitted herewith for filing is the patent application of: Inventors: Shunpei YAMAZAKI, Akira TAKENOUCHI, Yasuhiko TAKEMURA					
	For:	METHOD OF FABRICATING SEMICONDUCTOR DEVICES AND APPARATUS FOR PROCESSING A SEMICONDUCTOR				
	Enclosed are:					
	[X]	19 pages of specification and claims				
	5 sheets of informal drawings (Figures 1-6)					
	[X]	An assignment of the invention to <u>Semiconductor Energy Laboratory</u> <u>Co., Ltd.</u> .				
	[X]	Declaration and Power of Attorney.				
		Priority is claimed based on foreign application(s)				
	No(s):4-350546 and Not Yet Assigned Filed on: December 4, 1992 and November 5, 1993					
	Filed in: Japan					
	. Cer	tified copy(s) [] attached; [] filed on				
		in prior U.S.S.N				

A verified statement to establish small entity status under 37 CFR 1.9 and 37 CFR 1.27.

filed _____

[X] The filing fee has been calculated as shown below.

			Small/Large Entity		
For:	No. Filed	No. Extra	Rate	<u>Fee</u>	
Basic Fee		,		\$710.00	
Total Claim	s <u>20`</u> - 20 =	= 0	x 11/2	22	
Indep Claim	3 - 3 =	= 0	x 37/	74	
[] Multiple	e Dependent C	laim	+ 115/23	30	
			TOTAL	\$ <u>710.00</u>	
[X] Assignment Recordation Fee					
	\$ <u>750.00</u>				

- [X] A check in the amount of \$750.00 to cover the filing fee is enclosed.
- [X] The Commissioner is hereby authorized to charge fees under 37 CFR 1.16, 1.17, 1.20(a), 1.20(b), 1.20(c) and 1.20(d) (except the Issue Fee) which may be required now or hereafter, or credit any overpayment, to Deposit Account No. 19-2380. A duplicate copy of this sheet is attached.

Respectfully submitted,

Gerald J. Ferguson, Jr.

Registration No. 23,016

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